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IEEE ICME 2007 Call for Papers 2007 International Conference on Multimedia & Expo (ICME)

July 2-5, 2007

Beijing International Convention Center, Beijing, China









Sponsored by: Circuits and Systems Society, Communications Society, Computer Society, and Signal Processing Society

IEEE International Conference on Multimedia & Expo is a major annual international conference with the objective of bringing together researchers, developers, and practitioners from academia and industry working in all areas of multimedia. ICME serves as a forum for the dissemination of state-of-the-art research, development, and implementations of multimedia systems, technologies and applications. ICME is co-sponsored by four IEEE societies including the Circuits and Systems Society, the Communications Society, the Computer Society, and the Signal Processing Society. The conference will feature world-class plenary speakers, exhibits, special sessions, tutorials, and paper presentations.

Prospective authors are invited to submit a four-page paper in double-column format including authors' names, affiliations, and a short abstract. Only electronic submissions will be accepted. Topics include but are not limited to:

- Audio, image, video processing
- Virtual reality and 3-D imaging
- Signal processing for media integration
- Multimedia communications and networking
- Multimedia security and content protection
- Multimedia human-machine interface and interaction
- Multimedia databases
- Multimedia computing systems and appliances
- Hardware and software for multimedia systems
- Multimedia standards and related issues
- Multimedia applications
- Multimedia and social media on the Internet

A number of awards will be presented to the Best Papers and Best Student Papers at the conference. Participation for special sessions and tutorial proposals are encouraged.

SCHEDULE

Special Session Proposals Due: December 1, 2006

Tutorial Proposals Due: December 1, 2006

Regular Paper Submissions Due: January 5, 2007

Notification of Acceptance: March 19, 2007

■ Camera-Ready Papers Due: **April 16, 2007**

Check the conference website http://www.icme2007.org for updates.

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